

## PRODUCT SPECIFICATION

# Part Number PL16J-WCG48

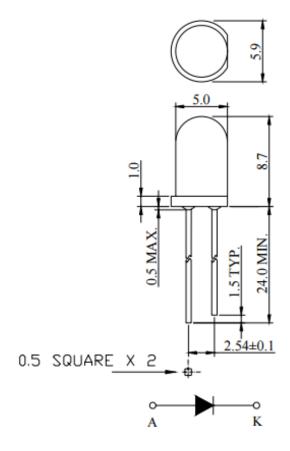
### **Details**

- 5mm Round Thru-Hole LED
- Emitting Color: True Green
- InGaN chip material
- Water Clear Epoxy Resin

### **Features**

- RoHS Compliant
- Low Power Consumption
- Rugged and Durable
- High Efficiency

### **Mechanical Dimensions**



#### Notes:

- 1. All dimensions are in millimeters unless otherwise noted
- 2. Tolerance is ±0.25mm unless otherwise noted





### **Device Selection Guide**

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Part Number	Material	Emitting Color	Lens Type
PL16J-WCG48	InGaN	True Green	Water Clear

### Absolute Maximum Ratings at Ta=25 °C

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	120	mW
Reverse Voltage	VR	5	V
DC Forward Current	IF	30	mA
Reverse (Leakage) Current	Ir	50	μΑ
Peak Current (duty cycle 1/10, 1KHz)	IPF	100	mA
Operating Temperature	Topr	-25~+85	°C
Storage Temperature	Tstg	-40~+100	°C
Soldering Temperature (1.6mm from body)	Tsol.	Dip Soldering : 260°C for 5 sec. Hand Soldering : 350°C for 3 sec.	
Electrostatic Discharge	ESD	1000	V

### Electrical and Optical Characteristics at Ta=25 $^{\circ}$ C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	4800	10000		mcd	
Forward Voltage	Vf		3.2	4.0	V	IF=20mA
Dominant Wavelength	λd		520		nm	
Reverse (Leakage) Current	Ir		1	50	μΑ	Vr=5V
Viewing Angle	2θ1/2		50		-	deg
Spectrum Line Halfwidth	Δλ		35		nm	IF=20mA

Notes: 1. IS tester used

<sup>2.</sup> Customer special requirements are welcomed.

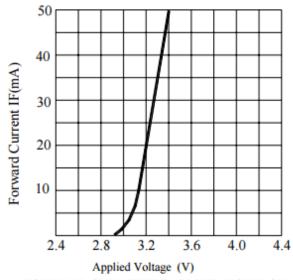
<sup>3.</sup> Specifications subject to change without notice



12500

10000

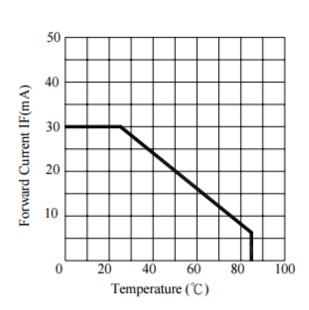
### Typical Electrical / Optical Characteristic Curves

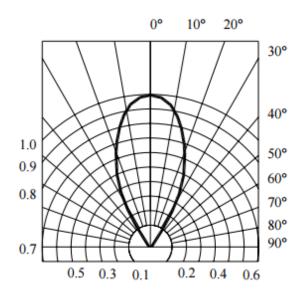


Relative Luminous Intensity 7500 5000 2500 20.0 10.0 30.0 Forward Current (mA)

FORWARD CURRENT VS.APPLIED VOLTAGE







FORWARD CURRENT VS. AMBIENT TEMPERATURE

RADIATION DIAGRAM



### Precautions for Use

### 1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately  $120-130^{\circ}$ C.

At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

### 2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

(2) Dip soldering:

Pre-heat: 90°C max. (Backside of PCB), Within 60 seconds.

Solder bath: 260±5°C (Solder temperature), Within 5 seconds.

(3) Hand soldering: 350°C max. (Temperature of soldering iron tip), Within 3 seconds.

#### 3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same.

#### 4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120°C max. Baking time: Within 60 seconds.

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.



	Approved By	Checked By	Prepared By
Customer Approval Signatures			

	Record Of Revisions		
Rev.	Comments	Page	Date
0	Released Spec		03/28/17